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350W,50V RF LDMOS Transistor

Description

The ITGV10350BY4 is a 350watt capable, Doherty paired LDMOS transistor, ideal for for 4G/5G cellular applications from 0.6 to 1GHz...

It can be configured as asymmetrical Doherty delivering 45-55W average power, according to normal 8-9dB back off.

There is no guarantee of performance when this part is used outside of stated frequencies.

Typical Doherty RF Performance (On Innogration fixture with device soldered).

Vds=50V Idq_main=250mA, Vgs_peak=1.5V

Eroa	Pu	lse CW Si	gnal	Pav	_g =47.5dBm W	CDMA Signal
Freq (MHz)	Gain P1dB (dB)	P3dB (W)	Eff@P3dB (%)	Gp (dB)	Eff(%)	ACPR₅M (dBc)
869	22.0	361	54.8	22.5	47	-26.5
881	21.7	368	55.5	22.2	48	-27.7
894	21.1	383	56.5	21.7	48	-30.3

Applications

- Asymmetrical Doherty amplifier within 0.6-1GHz
- UHF TV
- P band power amplifier

Figure 1: Pin Connection definition

Transparent top view (Backside grounding for source)

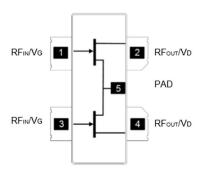
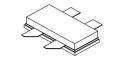


Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+110	Vdc
GateSource Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C



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Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	0.6	°C/W
T _C = 85°C, T _J =200°C, DC test	RejC	0.0	-C/VV

Table 3. ESD Protection Characteristics

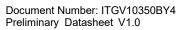
Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics (TA = 25 $^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics					
Drain-Source Voltage	.,		110		\
V _{GS} =0, I _{DS} =100uA	$V_{(BR)DSS}$		110		V
Zero Gate Voltage Drain Leakage Current				1	^
$(V_{DS} = 90V, V_{GS} = 0 V)$	I _{DSS}			ı	μΑ
GateSource Leakage Current	I _{GSS}			1	μΑ
$(V_{GS} = 11 \text{ V}, V_{DS} = 0 \text{ V})$	IGSS			ı	μΑ
Gate Threshold Voltage	V _{GS} (th)		2		V
$(V_{DS} = 50V, I_D = 600 \mu A)$	V GS(U1)				V
Gate Quiescent Voltage	$V_{GS(Q)}$		3.3		V
(V _{DD} = 50V, I _D = 250mA, Measured in Functional Test)	▼ GS(Q)		0.0		V

 $\textbf{Load Mismatch (In Innogration Test Fixture, 50 ohm system):} \quad V_{DD} = 50 \text{Vdc}, \ I_{DQ} = 250 \text{mA}, \ f = 894 \ \text{MHz}$

VSWR 10:1 at 50W WCDMA Output Power	No Device Degradation
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869-894MHz application board

Reference Circuit of Test Fixture Assembly Diagram 20mils RO4350B

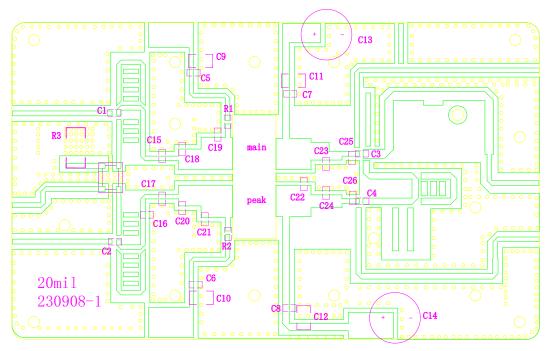


Figure 2. Test Circuit Component Layout

Table 5. Test Circuit Component Designations and Values

Designator	Footprint	Comment	Quantity
C1, C2, C18, C19, C20, C21, C25, C26	0603	10 pF	8
C3	0603	6.8 pF	1
C4, C5, C6, C7, C8	0603	68 pF	5
C9, C10, C11, C12	1210	10uF/100V	4
C13, C14		220uF/63V	2
C15, C16, C17, C22, C23, C24	0603	2.7 pF	6
R1,R2	0603	10R	2
R3	2512	51R	1
W1		DC07F02 (YANTEL 2dB)	1

(pF capacitors are ATC 600S series)



TYPICAL CHARACTERISTICS

Figure 5. Power Gain and Drain Efficiency as function of Power Output at Idq=250mA

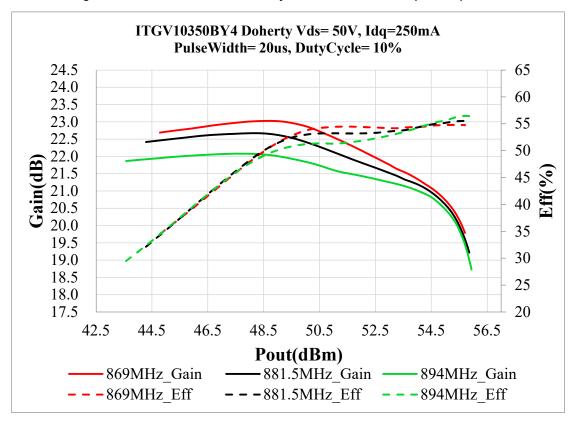
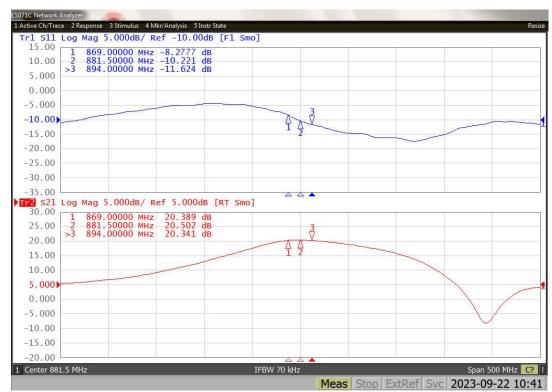


Figure 5.Network analyzer output S11/S21



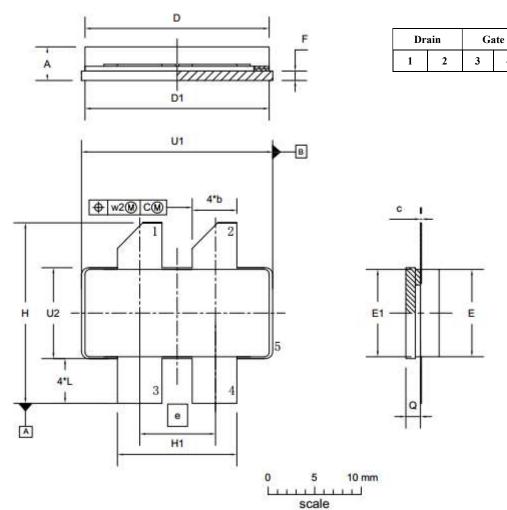


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Source

5

Earless Flanged Ceramic Package; 4 leads



UNIT	A	b	С	D	D ₁	е	E	E ₁	F	Н	H1	L	Q	U ₁	U ₂	W ₁	W ₂
	4.72	4.67	0.15	20.02	19.96	7.00	9.50	9.53	1.14	19.94	12.98	5.33	1.70	20.70	9.91	0.05	0.54
mm	3.43	4.93	0.08	19.61	19.66	7.90	9.30	9.25	0.89	18.92	12.73	4.32	1.45	20.45	9.65	0.25	0.51
inches	0.186	0.194	0.006	0.788	0.786	0.044	0.374	0.375	0.045	0.785	0.511	0.210	0.067	0.815	0.390	0.04	0.00
inches	0.135	0.184	0.003	0.772	0.774	0.311	0.366	0.364	0.035	0.745	0.501	0.170	0.057	0.805	0.380	0.01	0.02

OUTLINE		REFERENCE		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE BATE
PKG-B4					03/12/2013



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Revision history

Table 7. Document revision history

Date	Revision	Datasheet Status
2023/9/22	Rev 1.0	Preliminary Datasheet

Application data based on LSM-23-31

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